INTEGRATED CIRCUITS

DATA SHEET

SAA7124; SAA7125 Digital Video Encoder (ECO-DENC)

Preliminary specification
File under Integrated Circuits, IC22





SAA7124; SAA7125

FEATURES

- Monolithic CMOS 5 V device
- · Digital PAL/NTSC encoder
- · System pixel frequency 13.5 MHz
- Accepts MPEG decoded data on 8-bit wide input port.
 Input data format Cb, Y, Cr etc. "(CCIR 656)"
- Four DACs for CVBS (10-bit resolution), RGB (9-bit resolution) operating at 27 MHz; RGB sync on CVBS
- Optionally 2 times CVBS and Y, C (all 10-bit resolution) available simultaneously
- · Closed captioning encoding
- On-chip YUV to RGB dematrix optionally to be by-passed for Cr, Y, Cb output on RGB DACs
- Fast I²C-bus control port (400 kHz)
- · Encoder can be master or slave
- Programmable horizontal and vertical input synchronization phase, via input pins or auxiliary codes at MP data port
- · Programmable horizontal sync output phase
- Internal 100/75 Colour Bar Generator (CBG)
- Macrovision Pay-per-View copy protection system as option, also partly used for RGB output.

This applies to SAA7124 only. The device is protected by USA patent numbers 4631603, 4577216 and 4819098 and other intellectual property rights. Use of the Macrovision anti-copy process in the device is licensed for non-commercial home use only. Reverse engineering or disassembly is prohibited. Please contact your nearest Philips Semiconductor sales office for more information



- Controlled rise and fall times of output syncs and blanking
- Down-mode of DACs
- LQFP64 (V1 devices only), QFP80 or PLCC84 package.

GENERAL DESCRIPTION

The SAA7124; SAA7125 encodes digital YUV video data to an NTSC or PAL CVBS plus RGB or alternatively to S-Video and CVBS output.

Optionally, the YUV to RGB dematrix can be by-passed providing the digital-to-analog converted Cb, Y, Cr signals instead of RGB.

The circuit accepts CCIR compatible YUV data with 720 active pixels per line in 4 : 2 : 2 multiplexed formats, for example MPEG decoded data.

It includes a sync/clock generator and on-chip Digital-to-Analog Converters (DACs).

ORDERING INFORMATION

TYPE		PACKAGE ⁽¹⁾	
NUMBER	NAME	DESCRIPTION	VERSION
SAA7124WP; SAA7125WP	PLCC84	plastic leaded chip carrier; 84 leads	SOT189-2
SAA7124HZ; SAA7125HZ	LQFP64	plastic low profile quad flat package; 64 leads; body $10 \times 10 \times 1.4$ mm	SOT314-2
SAA7124H; SAA7125H	QFP80	plastic quad flat package; 80 leads (lead length 2.35 mm); body $14 \times 20 \times 2.8$ mm	SOT318-3

Note

1. LQFP64 package for V1 devices only.

Digital Video Encoder (ECO-DENC)

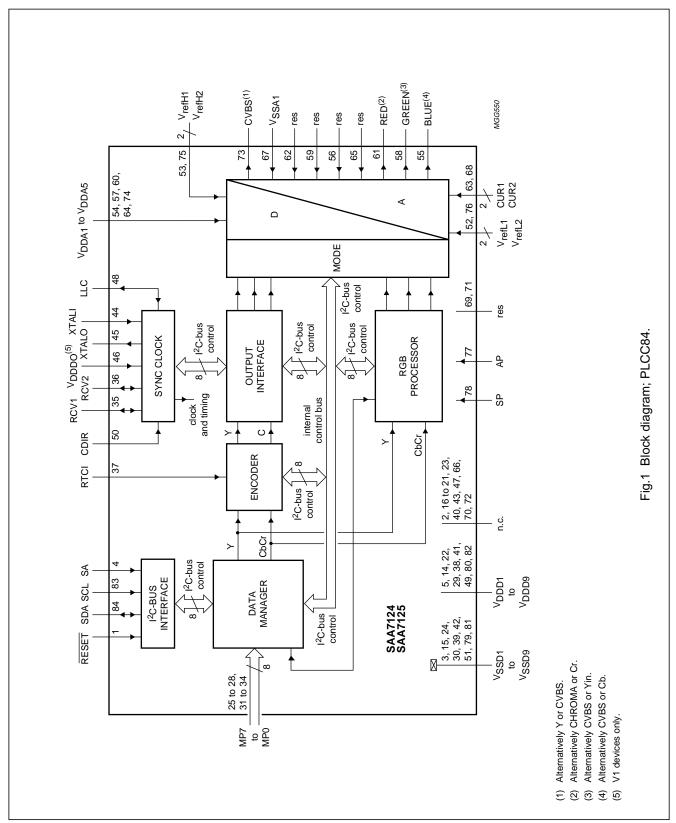
SAA7124; SAA7125

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MIN.	TYP.	MAX.	UNIT
V_{DDA}	analog supply voltage	4.75	5.0	5.25	V
V_{DDD}	digital supply voltage	4.75	5.0	5.25	V
I _{DDA}	analog supply current	_	tbf	60	mA
I _{DDD}	digital supply current	_	tbf	100	mA
Vi	input signal voltage levels	TT	L compati	ble	
V _{o(p-p)}	analog output signal voltages Y, C, CVBS and RGB without load (peak-to-peak value)		2.0	_	V
R _L	load resistance	80	_	_	Ω
ILE	LF integral linearity error	_	_	±4	LSB
DLE	LF differential linearity error	_	_	±1	LSB
T _{amb}	operating ambient temperature	0	_	+70	°C

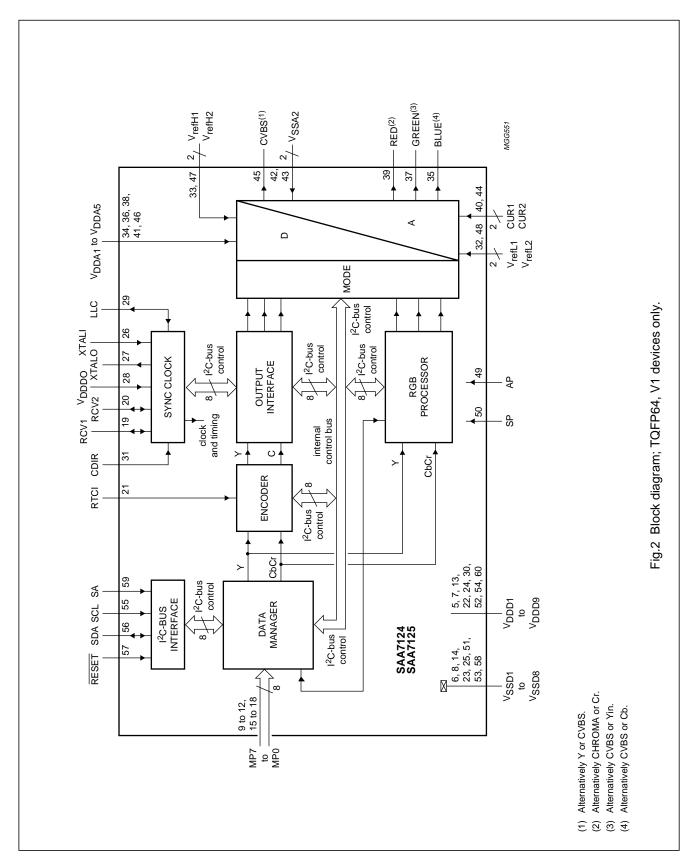
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BLOCK DIAGRAM



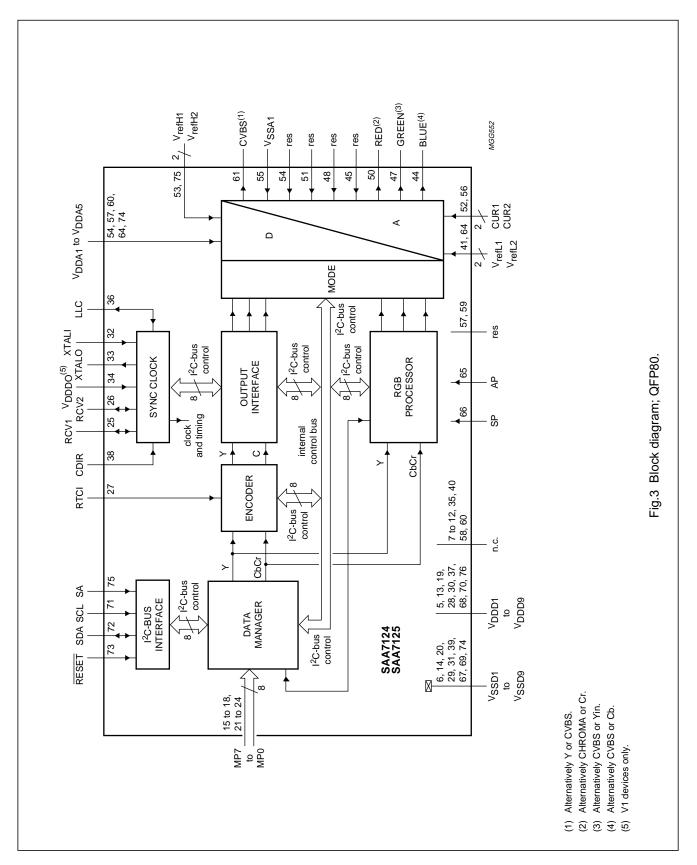
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Digital Video Encoder (ECO-DENC)

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PINNING

CVMDO	TVDE		PIN			
SYMBOL	TYPE	PLCC84	LQFP64	QFP80		
RESET	I	1	57	73	Reset input, active LOW. After reset is applied, all digital I/O are in input mode. The I ² C-bus receiver waits for the START condition.	
n.c.	_	2	_	_	not connected	
V _{SSD1}	I	3	6	6	digital ground 1	
SA	I	4	59	75	The I ² C-bus slave address select input pin. LOW: slave address = 88H, HIGH = 8CH.	
V_{DDD1}	I	5	5	5	digital supply voltage 1	
TP1	0	6	61	77		
TP2	0	7	62	78		
TP3	0	8	63	79		
TP4	0	9	64	80	Toot nin outpute. Loove open for narrael anarration	
TP5	0	10	1	1	Test pin outputs. Leave open for normal operation.	
TP6	0	11	2	2		
TP7	0	12	3	3		
TP8	0	13	4	4		
V_{DDD2}	I	14	7	13	digital supply voltage 2	
V _{SSD2}	I	15	8	14	digital ground 2	
n.c.	_	16	_	7		
n.c.	_	17	_	8	not connected	
n.c.	_	18	_	9		
n.c.	_	19	_	10		
n.c.	_	20	_	11		
n.c.	_	21	_	12		
$V_{\rm DDD3}$	I	22	13	19	digital supply voltage 3	
n.c.	_	23	_	_	not connected	
V _{SSD3}	I	24	14	20	digital ground 3	
MP7	I	25	9	15		
MP6	I	26	10	16	Upper 4 bits of MPEG port. It is an input for "CCIR 656" style	
MP5	I	27	11	17	multiplexed Cb, Y, Cr data.	
MP4	I	28	12	18	1	
V_{DDD4}	I	29	22	28	digital supply voltage 4	
V _{SSD4}	I	30	23	29	digital ground 4	
MP3	I	31	15	21		
MP2	I	32	16	22	Lower 4 bits of MPEG port. It is an input for "CCIR 656" style	
MP1	I	33	17	23	multiplexed Cb, Y, Cr data.	
MP0	I	34	18	24		
RCV1	I/O	35	19	25	Raster Control 1 for video port. This pin receives/provides a VS/FS/FSEQ signal.	

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CVMDOL	TVDE		PIN		DESCRIPTION Rester Central 2 for video part. This pin provides on US pu	
SYMBOL	TYPE	PLCC84	LQFP64	QFP80		
RCV2	I/O	36	20	26	Raster Control 2 for video port. This pin provides an HS pulso of programmable length or receives an HS pulse.	
RTCI	I	37	21	27	Real Time Control input. If the LLC clock is provided by an SAA7111 or SAA7151B, RTCI should be connected to the RTCO pin of the respective decoder to improve the signal quality.	
V_{DDD5}	I	38	24	30	digital supply voltage 5	
V _{SSD5}	I	39	25	31	digital ground 5	
n.c.	-	40	_	35	not connected	
V_{DDD6}	I	41	30	37	digital supply voltage 6	
V _{SSD6}	I	42	51	39	digital ground 6	
n.c.	_	43	_	40	not connected	
XTALI	I	44	26	32	Crystal oscillator input (from crystal). If the oscillator is not used, this pin should be connected to ground.	
XTALO	0	45	27	33	Crystal oscillator output (to crystal).	
V_{DDDO}	I	46	28	34	digital supply voltage for the internal oscillator; note 1	
n.c.		47	_	_	not connected	
LLC	I/O	48	29	36	Line-Locked Clock. This is the 27 MHz master clock for the encoder. The I/O direction is set by the CDIR pin.	
V_{DDD7}	I	49	52	68	digital supply voltage 7	
CDIR	I	50	31	38	Clock direction. If CDIR input is HIGH, the circuit receives a clock signal, otherwise if CDIR is LOW, LLC is generated by the internal crystal oscillator.	
V _{SSD7}	I	51	53	67	digital ground 7	
V _{refL1}	I	52	32	41	Lower reference voltage 1 input for DACs; connect to analoground.	
V _{refH1}	I	53	33	42	Upper reference voltage 1 input for DACs; connect via 100 nF capacitor to analog ground.	
V _{DDA1}	I	54	34	43	Analog supply voltage 1 for DACs.	
BLUE	0	55	35	44	Analog output of the BLUE component.	
res	Ι	56	_	45	reserved	
V_{DDA2}	I	57	36	46	Analog supply voltage 2 for DACs.	
GREEN	0	58	37	47	Analog output of GREEN component.	
res	I	59	_	48	reserved	
V_{DDA3}	Ι	60	38	49	Analog supply voltage 3 for DACs.	
RED	0	61	39	50	Analog output of RED component.	
res	I	62	_	51	reserved	
CUR1	I	63	40	52	Current input 1 for RGB amplifiers; connect via 15 k Ω resistor to V_{DDA} .	
V _{DDA4}	I	64	41	53	Analog supply voltage 4 for DACs.	
res	I	65	_	54	reserved	
n.c.	_	66	_	_	not connected	

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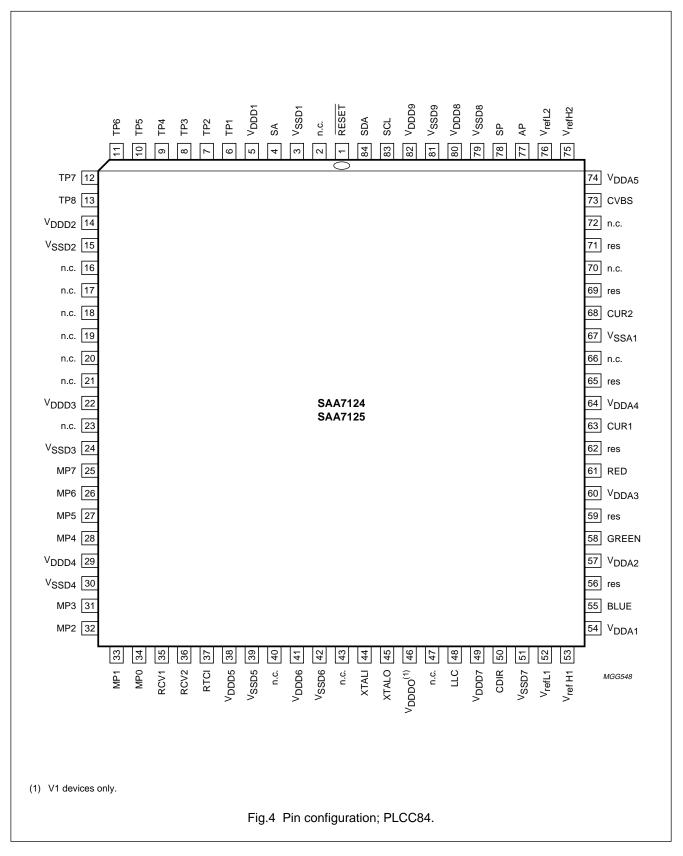
SYMBOL	TYPE	PIN			DESCRIPTION	
STIVIBUL	ITPE	PLCC84	LQFP64	QFP80	DESCRIPTION	
V _{SSA1}	I	67	42	55	Analog ground 1 for the DACs.	
V _{SSA2}	I	_	43	_	Analog ground 2 for the DACs.	
CUR2	I	68	44	56	Current input 2 for RGB amplifiers; connect via 15 k Ω resistor to V_{DDA} .	
res	0	69	_	57	reserved	
n.c.	_	70	_	58	not connected	
res	0	71	_	59	reserved	
n.c.	_	72	_	60	not connected	
CVBS	0	73	45	61	Analog output of the CVBS signal.	
V_{DDA5}	I	74	46	62	Analog supply voltage 5 for DACs.	
V _{refH2}	I	75	47	63	Upper reference voltage 2 input for DACs; connect via 100 nF capacitor to analog ground.	
V _{refL2}	I	76	48	64	Lower reference voltage 2 input for DACs; connect to analog ground.	
AP	I	77	49	65	Test pin. Connected to digital ground for normal operation.	
SP	I	78	50	66	Test pin. Connected to digital ground for normal operation.	
V _{SSD8}	I	79	58	69	digital ground 8	
V_{DDD8}	I	80	54	70	digital supply voltage 8	
V _{SSD9}	I	81	_	74	digital ground 9	
V _{DDD9}	I	82	60	76	digital supply voltage 9	
SCL	I	83	55	71	I ² C-bus serial clock input.	
SDA	I/O	84	56	72	I ² C-bus serial data input/output.	

Note

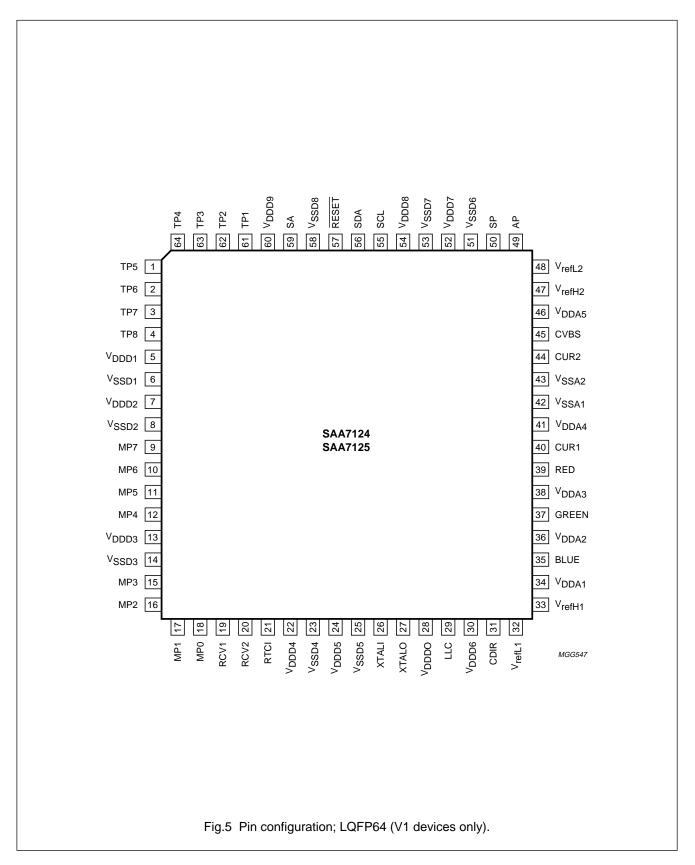
1. V1 devices only.

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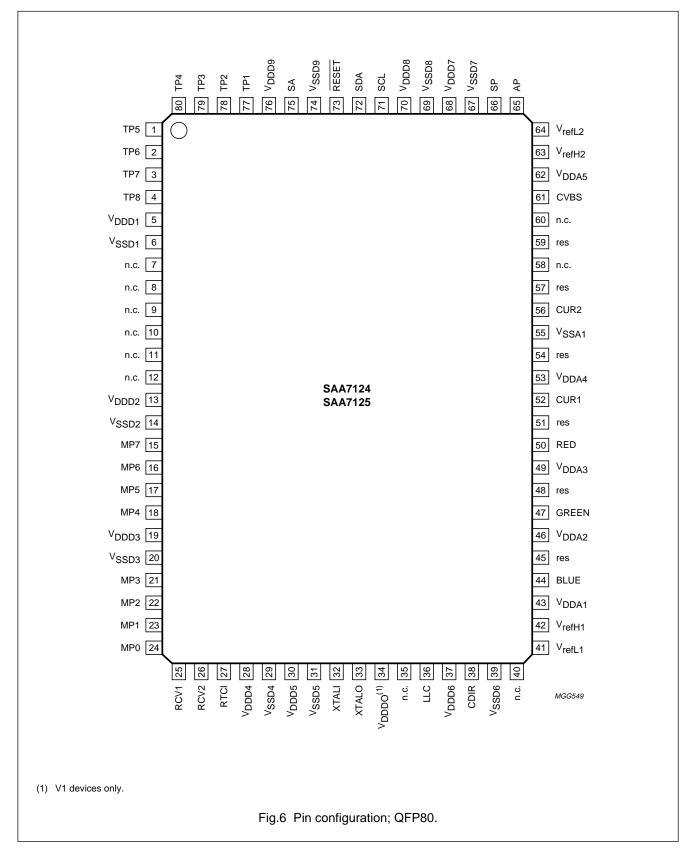


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Digital Video Encoder (ECO-DENC)

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FUNCTIONAL DESCRIPTION

The digital video encoder (ECO-DENC) encodes digital luminance and colour difference signals into analog CVBS and simultaneously RGB signals. NTSC-M, PAL B/G standards and sub-standards are supported.

Both interlaced and non-interlaced operation is possible for all standards.

Optionally, the input Y, Cb and Cr data, digital-to-analog converted, is available at the analog RGB outputs.

For applications that do not require RGB output, the device can be configured in such a way that S-Video and twice CVBS is available (Y at CVBS-DAC, C at R-DAC, and CVBS at G-DAC and B-DAC).

The basic encoder function consists of subcarrier generation, colour modulation and insertion of synchronization signals. Luminance and chrominance signals are filtered in accordance with the standard requirements of "RS-170-A" and "CCIR 624".

For ease of analog post filtering the signals are twice oversampled with respect to the pixel clock before digital-to-analog conversion.

For total filter transfer characteristics see Figs 7, 8, 9, 10, 11 and 12. The DACs for Y, C, and CVBS are realized with full 10-bit resolution, DACs for RGB with 9-bit resolution.

The MPEG port (MP) accepts 8 line multiplexed Cb, Y, Cr data.

The 8-bit multiplexed Cb-Y-Cr formats are "CCIR 656" (D1 format) compatible, but auxiliary codes such as SAV and EAV are decoded optionally for trigger purposes.

A crystal-stable master clock (LLC) of 27 MHz, which is twice the CCIR line-locked pixel clock of 13.5 MHz, needs to be supplied externally. Optionally, a crystal oscillator input/output pair of pins and an on-chip clock driver is provided.

It is also possible to connect a Philips Digital Video Decoder (SAA7111 or SAA7151B) in conjunction with a CREF clock qualifier to ECO-DENC. Via the RTCI pin, connected to RTCO of a decoder, information concerning actual subcarrier, PAL-ID, and if connected to SAA7111, definite subcarrier phase can be inserted.

The ECO-DENC synthesizes all necessary internal signals, colour subcarrier frequency, and synchronization signals, from that clock.

The encoder can be configured as slave with respect to RCV trigger inputs or auxiliary "CCIR 656" codes, or can be master to output horizontal and vertical trigger pulses.

The IC also contains Closed Caption and Extended Data Services Encoding (Line 21), and supports anti-taping signal generation in accordance with Macrovision.

A number of possibilities are provided for setting different video parameters such as:

Black and blanking level control

Colour subcarrier frequency

Variable burst amplitude etc.

During reset ($\overline{\text{RESET}}$ = LOW) and after reset is released, all digital I/O stages are set to input mode. A reset forces the I²C-bus interface to abort any running bus transfer and sets register 3A to 03H, register 61 to 06H and registers 6BH and 6EH to 00H. All other control registers are not influenced by a reset.

Data manager

In the data manager, real time arbitration on the data stream to be encoded is performed.

Optionally, the device can operate as a 100/75 colour bar test pattern generator without need for an external data source.

Encoder

VIDEO PATH

The encoder generates out of Y, U and V baseband signals luminance and colour subcarrier output signals, suitable for use as CVBS or separate Y and C signals.

Luminance is modified in gain and in offset (latter programmable in a certain range to enable different black level set-ups). After having been inserted a fixed synchronization level, in accordance with standard composite synchronization schemes, and blanking level, programmable also in a certain range to allow for manipulations with Macrovision anti-taping, additional insertion of AGC super-white pulses, programmable in height, is supported.

In order to enable easy analog post filtering, luminance is interpolated from 13.5 MHz data rate to 27 MHz data rate, providing luminance in 10-bit resolution. This filter is also used to define smoothed transients for synchronization pulses and blanking period. For transfer characteristic of the luminance interpolation filter see Figs 9 and 10.

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Chrominance is modified in gain (programmable separately for U and V), standard dependent burst is inserted, before baseband colour signals are interpolated from 6.75 MHz data rate to 27 MHz data rate. One of the interpolation stages can be bypassed, thus providing a higher colour bandwidth, which can be made use of for Y and C output. For transfer characteristics of the chrominance interpolation filter see Figs 7 and 8.

The amplitude of inserted burst is programmable in a certain range, suitable for standard signals and for special effects. Behind the succeeding quadrature modulator, colour in 10-bit resolution is provided on subcarrier.

The numeric ratio between Y and C outputs is in accordance with set standards.

CLOSED CAPTION ENCODER

Using this circuit, data in accordance with the specification of Closed Caption or Extended Data Service, delivered by the control interface, can be encoded (Line 21). Two dedicated pairs of bytes (two bytes per field), each pair preceded by run-in clocks and framing code, are possible.

The actual line number where data is to be encoded in, can be modified in a certain range.

Data clock frequency is in accordance with definition for NTSC-M standard 32 times horizontal line frequency.

Data LOW at the output of the DACs corresponds to 0 IRE, data HIGH at the output of the DACs corresponds to approximately 50 IRE.

It is also possible to encode Closed Caption Data for 50 Hz field frequencies at 32 times horizontal line frequency.

ANTI-TAPING (SAA7124 ONLY)

For more information contact your nearest Philips Semiconductors sales office.

RGB processor

This block contains a dematrix in order to produce RED, GREEN and BLUE signals to be fed to a SCART plug.

Before Y, Cb and Cr signals are de-matrixed, 2 times oversampling for luminance and 4 times oversampling for colour difference signals is performed. For transfer curves of luminance and colour difference components of RGB see Figs 11 and 12.

Output interface/DACs

In the output interface encoded both Y and C signals are converted from digital-to-analog in 10-bit resolution. Y and C signals are also combined to a 10-bit CVBS signal.

RED, GREEN and BLUE signals (optionally Cr, Y, Cb) are also converted from digital-to-analog, each providing a 9-bit resolution.

All output occurs with the same processing delay. Absolute amplitudes at the input of the DAC for CVBS is reduced by $^{15}\!\!/_{16}$ with respect to Y and C DACs to make maximum use of conversion ranges.

Depending on control bits YC_EN and DEMOFF, different signal combinations are available at DACs #1 to #4. YC_EN = DEMOFF = LOW is the default configuration after reset.

Table 1 Control of DAC signals

YC_EN	DEMOFF	DAC1	DAC2	DAC3	DAC4
0	0	CVBS	R	G	В
0	1	CVBS	Cr	Υ	Cb
1	0	VBS	С	CVBS	CVBS
1	1	VBS	С	CVBS	CVBS

Outputs of the DACs can be set together in two groups (#1 and #2 by DOWNB, #3 and #4 by DOWNA) via software control to minimum output voltage for either purpose.

Synchronization

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Synchronization of the ECO-DENC is able to operate in two modes; slave mode and master mode.

In the slave mode, the circuit accepts synchronization pulses at the bidirectional RCV1 port (or equivalently as frame synchronization from "CCIR 656" data stream). The timing and trigger behaviour related to RCV1 can be influenced by programming the polarity and on-chip delay of RCV1. Active slope of RCV1 defines the vertical phase and optionally the odd/even and colour frame phase to be initialized, it can be also used to set the horizontal phase.

If the horizontal phase is not to be influenced by RCV1, a horizontal pulse needs to be supplied at the RCV2 pin (or a horizontal synchronization from "CCIR 656" data stream). Timing and trigger behaviour can also be influenced for RCV2.

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If there are missing pulses at RCV1 and/or RCV2, the time base of ECO-DENC runs free, thus an arbitrary number of synchronization slopes may miss, but no additional pulses (with the incorrect phase) must occur.

If the vertical and horizontal phase is derived from RCV1, RCV2 can be used for horizontal or composite blanking input or output.

Alternatively, the device can be triggered by auxiliary codes in a "CCIR 656" data stream at the MP port.

In the master mode, the time base of the circuit continuously runs free. On the RCV1 port, the IC can output:

- A Vertical Sync signal (VS) with 3 or 2.5 lines duration, or;
- An ODD/EVEN signal which is LOW in odd fields, or;
- A field sequence signal (FSEQ) which is HIGH in the first of 4, 8 fields respectively.

On the RCV2 port, the IC can provide a horizontal pulse with programmable start and stop phase; this pulse can be inhibited in the vertical blanking period to build up, for example, a composite blanking signal.

The polarity of both RCV1 and RCV2 is selectable by software control.

Field length is in accordance with to 50 Hz or 60 Hz standards, including non-interlaced options; start and end of its active part can be programmed. The active part of a field always starts at the beginning of a line, If the standard blanking option SBLBN is not set.

I²C-bus interface

The I²C-bus interface is a standard slave transceiver, supporting 7-bit slave addresses and 400 kbits/s guaranteed transfer rate. It uses 8-bit subaddressing with an auto-increment function. All registers are write only, except one readable status byte.

Two I²C-bus slave addresses are selected:

88H: LOW at pin SA 8CH: HIGH at pin SA.

Input levels and formats

ECO-DENC expects digital Y, Cb, Cr data with levels (digital codes) in accordance with "CCIR 601".

For C and CVBS outputs, deviating amplitudes of the colour difference signals can be compensated by independent gain control setting, while gain for luminance is set to predefined values, distinguishable for 7.5 IRE set-up or without set-up.

For RGB (or Y, Cb and Cr) outputs fixed amplification in accordance with "CCIR 601" is provided.

Reference levels are measured with a colour bar, 100% white, 100% amplitude and 100% saturation.

TRANSFORMATION

 $R = Y + 1.3707 \times (Cr - 128)$

 $G = Y - 0.3365 \times (Cb - 128) - 0.6982 \times (Cr - 128)$

 $B = Y + 1.7324 \times (Cb - 128).$

Representation of R, G and B at the output is 9 bits at 27 MHz.

Table 2 8-bit multiplexed format (similar to "CCIR 656")

TIME				ВІ	тѕ				
TIME	0	1	2	2	4	5	6	7	
Sample	Cb ₀	Y ₀	Cr ₀	Y ₁	Cb ₂	Y ₂	Cr ₂	Y ₃	
Luminance pixel number	(0		1		2		3	
Colour pixel number		(0		2		2		

BLCKL0

BLNNL0

BLNVB0

BSTA0 FSC00 FSC08 FSC16

FISE

0

GAINUO

Digital Video Encoder (ECO-DENC)

UV2C

0

0

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Slave receiver (slave address 88H or 8CH)

Table 3

Bit allocation map

0

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L21E10

L21E00

HTRIG0 VTRIG0

FLCO

PRCV2

L21000 L21010

FSC24

ORCV2 VTRIG1 **BLCKL1** FSC09 FSC25 GAINU1 GAINV1 FSC17 L21001 L21011 HTRIG1 BLNNL1 L21E01 L21E11 BLNVB1 FSC01 **BSTA1** FLC1 Y2C PAL 0 2 0 0 0 0 L21002 L21012 **GAINU2 GAINV2 BLCKL2 BLNNL2 BLNVB2** HTRIG2 VTRIG2 CHPS2 FSC18 FSC26 FSC10 L21E02 L21E12 BSTA2 FSC02 SCBW CBLF 22 0 0 0 0 **GAINV3** L21003 L21013 L21E13 CHPS3 **GAINU3 BLNNL3 BLNVB3** FSC03 HTRIG3 DEMOFF L21E03 PRCV1 VTRIG3 FSC19 FSC11 FSC27 23 0 0 0 0 0 DATA BYTE⁽¹⁾ L21014 CHPS4 **GAINU4** GAINV4 **BLCKL4 BLNNL4 BLNVB4** FSC12 FSC28 ORCV1 HTRIG4 VTRIG4 FSC20 L21004 L21E14 BSTA4 FSC04 L21E04 SYMP YGS 7 0 0 0 0 **BLCKL5** PHRES1 L21015 GAINV5 **BLNNL5 BLNVB5** CHPS5 **GAINU5** TRCV2 HTRIG5 HTRIG8 FSC29 L21E15 FSC13 L21005 L21E05 FSC05 Ш BSTA5 FSC21 0 0 0 0 Z C DECTYP SRCV10 CHPS6 **GAINU6** GAINV6 L21016 HTRIG6 HTRIG9 DOWNA BSTA6 FSC22 L21E16 FSC30 L21E06 FSC06 FSC14 L21006 90 0 0 0 HTRIG10 GAINU8 GAINV8 DOWNB CBENB CHPS7 L21017 L21E17 L21007 SBLBN GAINU7 GAINV7 FSC07 FSC15 FSC23 SRCV11 HTRIG7 FSC31 L21E07 7 0 0 0 **ADDRESS** SUB 5C 5B 8 39 39 39 A 42 59 5A 5D 5E 62 63 64 65 66 67 99 69 6A 30 GD 9 61 RTC enable burst amplitude REGISTER FUNCTION Gain V MSB, blanking level Gain U MSB, black level Chrominance phase Blanking level VBI Standard control RCV port control Line 21 even 0 I/O port control Line 21 even 1 **Frigger** control **Trigger control** Line 21 odd 0 Line 21 odd 1 decoder type Subcarrier 3 Subcarrier 2 Subcarrier 0 Multi control Subcarrier 1 Gain V Gain U 3

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GEOM	SUB				DATA BYTE ⁽¹⁾	3YTE ⁽¹⁾			
REGISTER FUNCTION	ADDRESS	D7	9Q	D2	D4	D3	D2	10	D0
Closed caption	6F	CCEN1	CCENO	0	SCCLN4	SCCLN3	SCCLN2	SCCLN1	SCCLNO
RCV2 output start	70	RCV2S7	RCV2S6	RCV2S5	RCV2S4	RCV2S3	RCV2S2	RCV2S1	RCV2S0
RCV2 output end	7.1	RCV2E7	RCV2E6	RCV2E5	RCV2E4	RCV2E3	RCV2E2	RCV2E1	RCV2E0
MSBs RCV2 output	72	0	RCV2E10	RCV2E9	RCV2E8	0	RCV2S10	RCV2S9	RCV2S8
Null	73	0	0	0	0	0	0	0	0
Null	74	0	0	0	0	0	0	0	0
Null	75	0	0	0	0	0	0	0	0
Null	92	0	0	0	0	0	0	0	0
Null	77	0	0	0	0	0	0	0	0
Null	78	0	0	0	0	0	0	0	0
Null	62	0	0	0	0	0	0	0	0
First active line	7A	FAL7	FAL6	FAL5	FAL4	FAL3	FAL2	FAL1	FALO
Last active line	7B	LAL7	LAL6	LAL5	LAL4	LAL3	LAL2	LAL1	LALO
MSBs vertical	2C	0	8TYT	0	FAL8	0	0	0	0
Null	7D	0	0	0	0	0	0	0	0
Null	7E	0	0	0	0	0	0	0	0
Null	7F	0	0	0	0	0	0	0	0

Note
1. All bits marked 0 must be programmed to zero.

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I²C-bus format

Table 4 I²C-bus address; see Table 5

Table 5 Explanation of Table 4

PART	DESCRIPTION		
S	START condition		
Slave address	1 0 0 0 1 0 0 X or 1 0 0 0 1 1 0 X (note 1)		
ACK	acknowledge, generated by the slave		
Subaddress (note 2)	subaddress byte		
DATA	data byte		
	continued data bytes and ACKs		
Р	STOP condition		

Notes

- 1. X is the read/write control bit; X = logic 0 is order to write; X = logic 1 is order to read, no subaddressing with read.
- 2. If more than 1 byte DATA is transmitted, then auto-increment of the subaddress is performed.

Slave Receiver

Table 6 Subaddress 3A

DATA BYTE	LOGIC LEVEL	DESCRIPTION			
UV2C	0	Cb, Cr data are two's complement.			
	1	Cb, Cr data are straight binary. Default after reset.			
Y2C	0	Y data is two's complement.			
	1	Y data is straight binary. Default after reset.			
DEMOFF	0	Y, Cb and Cr for RGB dematrix is active. Default after reset.			
	1	Y, Cb and Cr for RGB dematrix is bypassed.			
SYMP	0	Horizontal and vertical trigger is taken from RCV2 and RCV1 respectively. Default after reset			
	1	Horizontal and vertical trigger is decoded out of "CCIR 656" compatible data at MP port.			
YC_EN	0	Output of CVBS and RGB signals. Default after reset.			
	1	Output of Y, C, and CVBS, CVBS signals.			
CBENB	0	Data from input ports is encoded. Default after reset.			
	1	Colour bar with fixed colours is encoded. The LUTs are read in upward order from index 0 to index 7.			

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Table 7 Subaddress 5A

DATA BYTE	DESCRIPTION	VALUE	RESULT
CHPS	phase of encoded colour	tbf	PAL-B/G and data from input ports
	subcarrier (including burst)	tbf	PAL-B/G and data from look-up table
	relative to horizontal sync. Can be adjusted in steps	tbf	NTSC-M and data from input ports
	of 360/256 degrees	tbf	NTSC-M and data from look-up table

Table 8 Subaddress 5B and 5D

DATA BYTE	DESCRIPTION	CONDITIONS	REMARKS
GAINU	variable gain for Cb signal;	white-to-black = 92.5 IRE(1)	
	input representation	GAINU = 0	output subcarrier of U contribution = 0
	accordance with "CCIR 601"	GAINU = 118 (76H)	output subcarrier of U contribution = nominal
		white-to-black = 100 IRE(2)	
		GAINU = 0	output subcarrier of U contribution = 0
		GAINU = 125 (7DH)	output subcarrier of U contribution = nominal

Notes

- 1. GAINU = $-2.17 \times$ nominal to $+2.16 \times$ nominal.
- 2. GAINU = $-2.05 \times$ nominal to $+2.04 \times$ nominal.

Table 9 Subaddress 5C and 5E

DATA BYTE	DESCRIPTION	CONDITIONS	REMARKS
GAINV	variable gain for Cr signal;	white-to-black = 92.5 IRE(1)	
	input representation	GAINV = 0	output subcarrier of V contribution = 0
	accordance with "CCIR 601"	GAINV = 165 (A5H)	output subcarrier of V contribution = nominal
		white-to-black = 100 IRE(2)	
		GAINV = 0	output subcarrier of V contribution = 0
		GAINV = 175 (AFH)	output subcarrier of V contribution = nominal

Notes

- 1. GAINV = $-1.55 \times$ nominal to $+1.55 \times$ nominal.
- 2. GAINV = $-1.46 \times$ nominal to $+1.46 \times$ nominal.

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Table 10 Subaddress 5D

DATA BYTE	DESCRIPTION	CONDITIONS	REMARKS
BLCKL	variable black level; input	white-to-sync = 140 IRE ⁽¹⁾	
	representation accordance	BLCKL = 0	output black level = 24 IRE
	with "CCIR 601"	BLCKL = 63 (3FH)	output black level = 49 IRE
		white-to-sync = 143 IRE ⁽²⁾	
		BLCKL = 0	output black level = 24 IRE
		BLCKL = 63 (3FH)	output black level = 50 IRE

Notes

- 1. Output black level/IRE = BLCKL × 25/63 + 24; recommended value: BLCKL = 60 (3CH) normal.
- 2. Output black level/IRE = BLCKL × 26/63 + 24; recommended value: BLCKL = 45 (2DH) normal.

Table 11 Subaddress 5E

DATA BYTE	DESCRIPTION	CONDITIONS	REMARKS
BLNNL	variable blanking level	white-to-sync = 140 IRE ⁽¹⁾	
		BLNNL = 0	output blanking level = 17 IRE
		BLNNL = 63 (3FH) output blanking level = 42 IRE	
		white-to-sync = 143 IRE ⁽²⁾	
		BLNNL = 0 output blanking level = 17 IRE	
		BLNNL = 63 (3FH)	output blanking level = 43 IRE
DECTYP	RTCI	logic 0	real time control input from SAA7151B
		logic 1	real time control input from SAA7111

Notes

- 1. Output black level/IRE = $BLNNL \times 25/63 + 17$; recommended value: BLNNL = 58 (3AH) normal.
- 2. Output black level/IRE = $BLNNL \times 26/63 + 17$; recommended value: BLNNL = 63 (3FH) normal.

Table 12 Subaddress 5F

DATA BYTE	DESCRIPTION
BLNVB	variable blanking level during vertical blanking interval is typically identical to value of BLNNL

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Table 13 Subaddress 61

DATA BYTE	LOGIC LEVEL	DESCRIPTION	
FISE	0	864 total pixel clocks per line; default after reset	
	1	858 total pixel clocks per line	
PAL	0	NTSC encoding (non-alternating V component)	
	1	PAL encoding (alternating V component); default after reset	
SCBW	0	enlarged bandwidth for chrominance encoding (for overall transfer characteristic of chrominance in baseband representation see Figs 7 and 8)	
	1	standard bandwidth for chrominance encoding (for overall transfer characteristic of chrominance in baseband representation see Figs 7 and 8); default after reset	
YGS 0 luminance gain for white – black 10		luminance gain for white – black 100 IRE; default after reset	
	1	luminance gain for white – black 92.5 IRE including 7.5 IRE set-up of black	
INPI	0	PAL switch phase is nominal; default after reset	
	1	PAL switch phase is inverted compared to nominal	
DOWNA	DWNA 0 DACs for G and B (Y and Cb or CVBS and CVBS) in normal operational default after reset		
	1	DACs for G and B (Y and Cb or CVBS and CVBS) forced to lowest output voltage	
DOWNB	0	DACs for CVBS and R (CVBS and Cr or VBS and C) in normal operational mode; default after reset	
	1	DACs for CVBS and R (CVBS and Cr or VBS and C) forced to lowest output voltage	

Table 14 Subaddress 62A

DATA BYTE	DESCRIPTION	CONDITIONS	REMARKS
BSTA	amplitude of colour burst; input representation in	white-to-black = 92.5 IRE; burst = 40 IRE; NTSC encoding	recommended value: BSTA = 102 (66H
	accordance with	BSTA = 0 to $1.25 \times \text{nominal}$	
	"CCIR 601"	white-to-black = 92.5 IRE; burst = 40 IRE; PAL encoding	recommended value: BSTA = 72 (48H)
		BSTA = 0 to $1.76 \times \text{nominal}$	
		white-to-black = 100 IRE; burst = 43 IRE; NTSC encoding	recommended value: BSTA = 106 (6AH)
		BSTA = 0 to $1.20 \times \text{nominal}$	
		white-to-black = 100 IRE; burst = 43 IRE; PAL encoding	recommended value: BSTA = 75 (4BH)
		BSTA = 0 to $1.67 \times \text{nominal}$	

Table 15 Subaddress 62B

DATA BYTE	LOGIC LEVEL	DESCRIPTION	
RTCE	0	no real time control of generated subcarrier frequency	
	1	real time control of generated subcarrier frequency through SAA7151B or SAA7111 (timing see Fig.15)	

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Table 16 Subaddress 63 to 66 (four bytes to program subcarrier frequency)

DATA BYTE	DESCRIPTION	CONDITIONS	REMARKS
FSC0 to FSC3	f _{fsc} = subcarrier frequency (in multiples of line frequency); f _{llc} = clock frequency (in	$FSC = round \left(\frac{f_{fsc}}{f_{llc}} \times 2^{32} \right)$ see note 1	FSC3 = most significant byte FSC0 = least significant byte
	multiples of line frequency)		

Note

- 1. Examples:
 - a) NTSC-M: f_{fsc} = 227.5, f_{IIc} = 1716 \rightarrow FSC = 569408543 (21F07C1FH).
 - b) PAL-B/G: f_{fsc} = 283.7516, f_{llc} = 1728 \rightarrow FSC = 705268427 (2A098ACBH).

Table 17 Subaddress 67 to 6A

DATA BYTE	DESCRIPTION	REMARK
L21O0	first byte of captioning data, odd field	LSB of the respective bytes are encoded immediately
L21O1	second byte of captioning data, odd field	after run-in and framing code, the MSBs of the
L21E0	first byte of extended data, even field	respective bytes have to carry the parity bit, in accordance with the definition of Line 21 encoding
L21E1	second byte of extended data, even field	format

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Table 18 Subaddress 6B

DATA BYTE	LOGIC LEVEL	DESCRIPTION		
PRCV2	0	polarity of RCV2 as output is active HIGH, rising edge is taken when input, respectively; default after reset		
	1	polarity of RCV2 as output is active LOW, falling edge is taken when input, respectively		
ORCV2	0	pin RCV2 is switched to input; default after reset		
	1	pin RCV2 is switched to output		
CBLF	0	if ORCV2 = HIGH, pin RCV2 provides an HREF signal (Horizontal Reference pulse that is defined by RCV2S and RCV2E, also during vertical blanking Interval); default after reset		
		if ORCV2 = LOW and bit SYMP = LOW, signal input to RCV2 is used for horizontal synchronization only (if TRCV2 = HIGH); default after reset		
	1	if ORCV2 = HIGH, pin RCV2 provides a 'Composite-Blanking-Not' signal, this is a reference pulse that is defined by RCV2S and RCV2E, excluding Vertical Blanking Interval, which is defined by FAL and LAL		
		if ORCV2 = LOW and bit SYMP = LOW, signal input to RCV2 is used for horizontal synchronization (if TRCV2 = HIGH) and as an internal blanking signal		
PRCV1 0 polarity of RCV1 as output is active HIGH, rising edge is taken whater reset		polarity of RCV1 as output is active HIGH, rising edge is taken when input; default after reset		
	1	polarity of RCV1 as output is active LOW, falling edge is taken when input		
ORCV1	0	pin RCV1 is switched to input; default after reset		
	1	pin RCV1 is switched to output		
TRCV2	0	horizontal synchronization is taken from RCV1 port (at bit SYMP = LOW) or from decoded frame sync of "CCIR 656" input (at bit SYMP = HIGH); default after reset		
	1	horizontal synchronization is taken from RCV2 port (at bit SYMP = LOW)		
SRCV1	_	defines signal type on pin RCV1; see Table 19		

Table 19 Logic levels and function of SRCV1

DATA BYTE		AS OUTPUT AS INPUT	FUNCTION	
SRCV11	SRCV10	AS OUTPUT	3 COTT OT AS INFOT	FUNCTION
0	0	VS	VS	vertical sync each field; default after reset
0	1	FS	FS	frame sync (odd/even)
1	0	FSEQ	FSEQ	field sequence, vertical sync every fourth field (PAL = 0) or eighth field (PAL = 1)
1	1	not applicable	not applicable	_

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Table 20 Subaddress 6C and 6D

DATA BYTE	DESCRIPTION
HTRIG	sets the horizontal trigger phase related to signal on RCV1 or RCV2 input (or to decoded "CCIR 656" data)
	values above 1715 (FISE = 1) or 1727 (FISE = 0) are not allowed
	increasing HTRIG decreases delays of all internally generated timing signals
	reference mark: analog output horizontal sync (leading slope) coincides with active edge of RCV used for triggering at HTRIG = tbfH (tbfH)

Table 21 Subaddress 6D

DATA BYTE	DESCRIPTION
VTRIG	sets the vertical trigger phase related to signal on RCV1 input (or to decoded "CCIR 656" data)
	increasing VTRIG decreases delays of all internally generated timing signals, measured in half lines
	variation range of VTRIG = 0 to 31 (1FH)

Table 22 Subaddress 6E

DATA BYTE	LOGIC LEVEL	DESCRIPTION			
SBLBN	0	vertical blanking is defined by programming of FAL and LAL; default after reset			
	1	vertical blanking is forced in accordance with "CCIR 624" (50 Hz) or "RS170A" (60 Hz)			
PHRES	_	selects the phase reset mode of the colour subcarrier generator; see Table 23			
FLC	_	field length control; see Table 24			

Table 23 Logic levels and function of PHRES

DATA BYTE		FUNCTION	
PHRES1	PHRES0	FUNCTION	
0	0	no reset or reset via RTCI from SAA7111 if bit RTCE = 1; default after reset	
0	1	reset every two lines	
1	0	reset every eight fields	
1	1	reset every four fields	

Table 24 Logic levels and function of FLC

DATA BYTE		FUNCTION	
FLC1	FLC0	FUNCTION	
0	0	interlaced 312.5 lines/field at 50 Hz, 262.5 lines/field at 60 Hz; default after reset	
0	1	non-interlaced 312 lines/field at 50 Hz, 262 lines/field at 60 Hz	
1	0	non-interlaced 313 lines/field at 50 Hz, 263 lines/field at 60 Hz	
1	1	non-interlaced 313 lines/field at 50 Hz, 263 lines/field at 60 Hz	

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Table 25 Subaddress 6F

DATA BYTE	DESCRIPTION
CCEN	enables individual Line 21 encoding; see Table 26
SCCLN	selects the actual line, where closed caption or extended data are encoded
	line = (SCCLN + 4) for M-systems
	line = (SCCLN + 1) for other systems

Table 26 Logic levels and function of CCEN

DATA BYTE		FUNCTION	
CCEN1	CCEN0	FUNCTION	
0	0	line 21 encoding off	
0	1	enables encoding in field 1 (odd)	
1	0	enables encoding in field 2 (even)	
1	1	enables encoding in both fields	

Table 27 Subaddress 70 to 72

DATA BYTE	DESCRIPTION
RCV2S	start of output signal on RCV2 pin
	values above 1715 (FISE = 1) or 1727 (FISE = 0) are not allowed
	first active pixel at analog outputs (corresponding input pixel coinciding with RCV2) at RCV2S = tbfH (tbfH)
RCV2E	end of output signal on RCV2 pin
	values above 1715 (FISE = 1) or 1727 (FISE = 0) are not allowed
	last active pixel at analog outputs (corresponding input pixel coinciding with RCV2) at RCV2E = tbfH (tbfH)

Table 28 Subaddress 7A to 7C

DATA BYTE	DESCRIPTION
FAL	first active line = FAL + 4 for M-systems, = FAL + 1 for other systems, measured in lines
	FAL = 0 coincides with the first field synchronization pulse
LAL	last active line = LAL + 3 for M-systems, = LAL for other system, measured in lines
	LAL = 0 coincides with the first field synchronization pulse

SUBADDRESSES

In subaddresses 5B, 5C, 5D, 5E and 62 all IRE values are rounded up.

Digital Video Encoder (ECO-DENC)

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Slave Transmitter

Table 29 Slave transmitter (slave address 89H or 8DH)

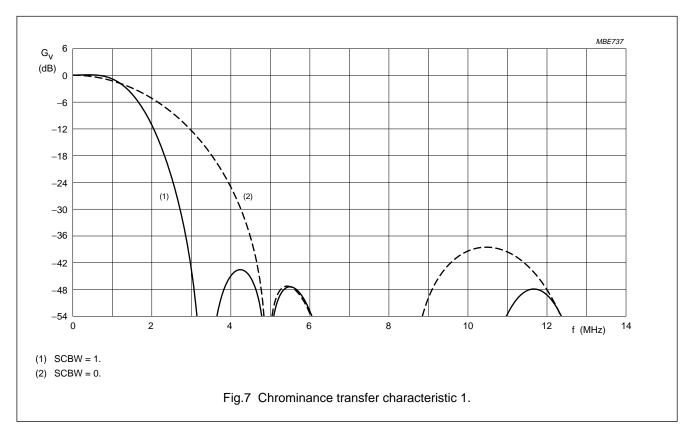
REGISTER CURADORES	SUBADDRESS				DATA	BYTE			
FUNCTION	SUBADDRESS	D7	D6	D5	D4	D3	D2	D1	D0
Status byte	_	VER2	VER1	VER0	CCRDO	CCRDE	0	FSEQ	O_E

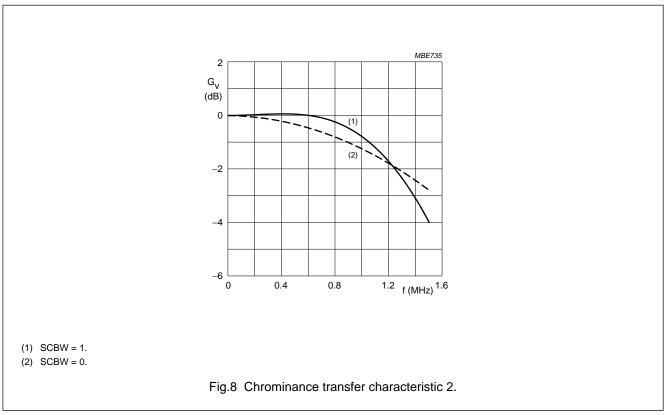
Table 30 No subaddress

DATA BYTE	LOGIC LEVEL	DESCRIPTION			
VER	-	Version identification of the device. It will be changed with all versions of the IC that have different programming models. Current Version is 100 binary.			
CCRDO	1	Closed caption bytes of the odd field have been encoded.			
	0	The bit is reset after information has been written to the subaddresses 67 and 68. It is set immediately after the data has been encoded.			
CCRDE 1		Closed caption bytes of the even field have been encoded.			
0		The bit is reset after information has been written to the subaddresses 69 and 6A. It is set immediately after the data has been encoded.			
FSEQ	1	During first field of a sequence (repetition rate: NTSC = 4 fields, PAL = 8 fields.			
	0	Not first field of a sequence.			
O_E	1	During even field.			
	0	During odd field.			

Digital Video Encoder (ECO-DENC)

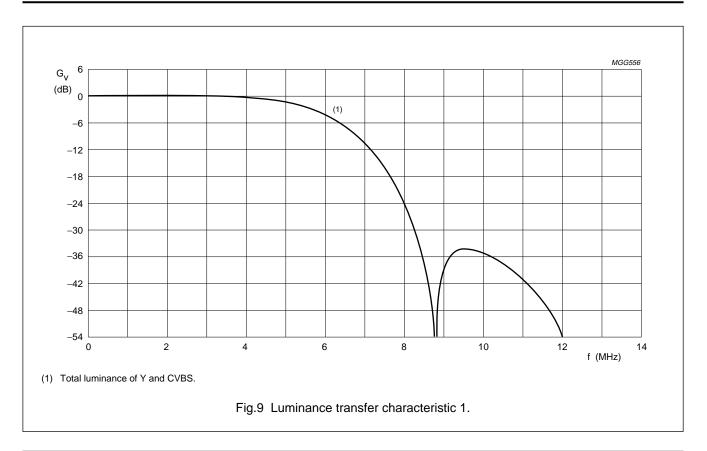
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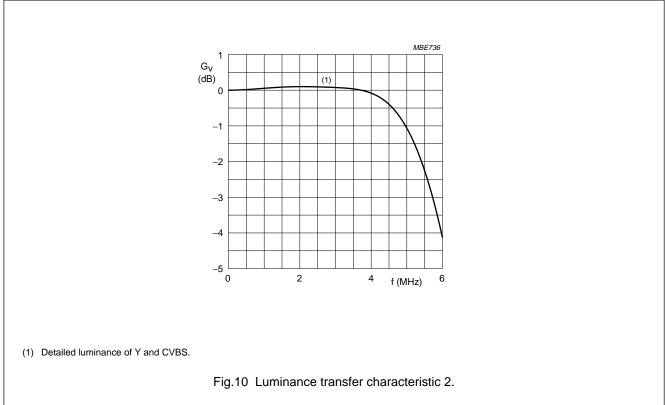




Digital Video Encoder (ECO-DENC)

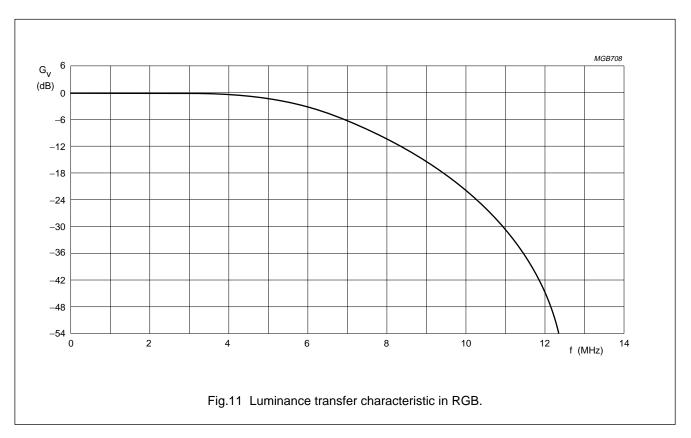
SAA7124; SAA7125

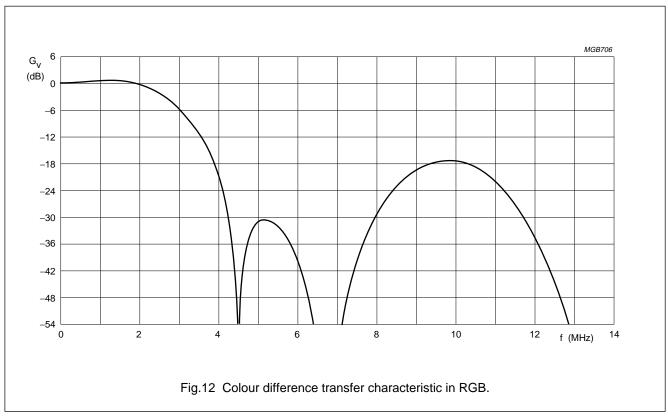




Digital Video Encoder (ECO-DENC)

SAA7124; SAA7125





SAA7124; SAA7125

CHARACTERISTICS

 V_{DDD} = 4.75 to 5.25 V; T_{amb} = 0 to +70 °C; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
		00.121110110			
Supplies	T , ,		4.75	5.05	1,,
V _{DDA}	analog supply voltage		4.75	5.25	V
V _{DDD}	digital supply voltage		4.75	5.25	V
I _{DDA}	analog supply current	note 1	-	60	mA
I _{DDD}	digital supply current	note 1		100	mA
Inputs					
V_{IL}	LOW level input voltage (except SDA, SCL, AP, SP and XTALI)		-0.5	+0.8	V
V _{IH}	HIGH level input voltage (except LLC, SDA, SCL, AP, SP and XTALI)		2.0	V _{DDD} + 0.5	V
	HIGH level input voltage (LLC)		2.4	V _{DDD} + 0.5	V
I _{LI}	input leakage current		_	1	μΑ
C _i	input capacitance	clocks	_	10	pF
		data	_	8	pF
		I/Os at high impedance	_	8	pF
Outputs			'		'
V _{OL}	LOW level output voltage (except SDA and XTALO)	note 2	0	0.6	V
V _{OH}	HIGH level output voltage (except LLC, SDA, and XTALO)	note 2	2.4	V _{DDD} + 0.5	V
	HIGH level output voltage (LLC)	note 2	2.6	V _{DDD} + 0.5	V
I ² C-bus; SI	DA and SCL		'		
V _{IL}	LOW level input voltage		-0.5	+1.5	V
V _{IH}	HIGH level input voltage		3.0	V _{DDD} + 0.5	V
l _i	input current	V _i = LOW or HIGH	-10	+10	μΑ
V _{OL}	LOW level output voltage (SDA)	I _{OL} = 3 mA	_	0.4	V
Io	output current	during acknowledge	3	_	mA
Clock timir	ng (LLC)				
T _{LLC}	cycle time	note 3	34	41	ns
δ	duty factor t _{HIGH} /T _{LLC}	note 4	40	60	%
t _r	rise time	note 3	_	5	ns
t _f	fall time	note 3	_	6	ns
Input timin		I.	-1		
t _{SU;DAT}	input data set-up time (any other except CDIR, SCL, SDA, RESET, AP and SP)		6	_	ns
t _{HD;DAT}	input data hold time (any other except CDIR, SCL, SDA, RESET, AP and SP)		3	_	ns

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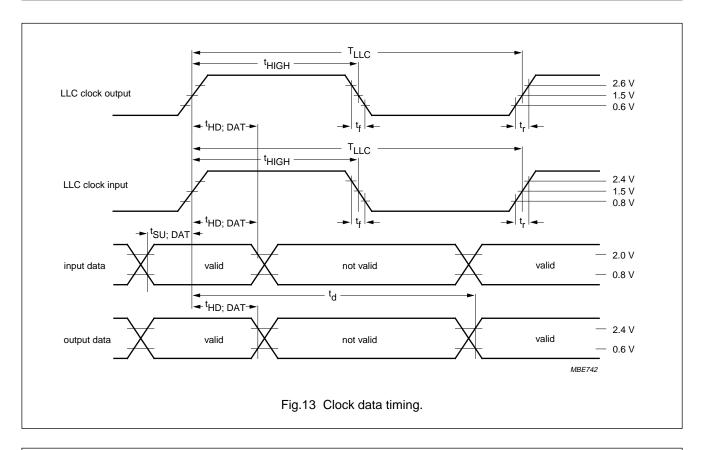
SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Crystal osc	cillator			1	
f _n	nominal frequency (usually 27 MHz)	3rd harmonic	_	30	MHz
$\Delta f/f_n$	permissible deviation of nominal frequency	note 5	-50	+50	10-6
CRYSTAL SP	ECIFICATION	,		-	-
T _{amb}	operating ambient temperature		0	70	°C
C _L	load capacitance		8	_	pF
R _S	series resistance		_	80	Ω
C ₁	motional capacitance (typical)		1.5 – 20%	1.5 + 20%	fF
C ₀	parallel capacitance (typical)		3.5 – 20%	3.5 + 20%	pF
Data and re	eference signal output timing				
C _L	output load capacitance		7.5	40	pF
t _h	output hold time		4	_	ns
t _d	output delay time		_	25	ns
CHROMA,	Y, CVBS and RGB outputs		•		
V _{o(p-p)}	output signal voltage (peak-to-peak value)	note 6	1.9	2.1	V
R _{int}	internal serial resistance		18	35	Ω
R _L	output load resistance		80	_	Ω
В	output signal bandwidth of DACs	-3 dB	10	_	MHz
ILE	LF integral linearity error of DACs		_	±4	LSB
DLE	LF differential linearity error of DACs		_	±1	LSB

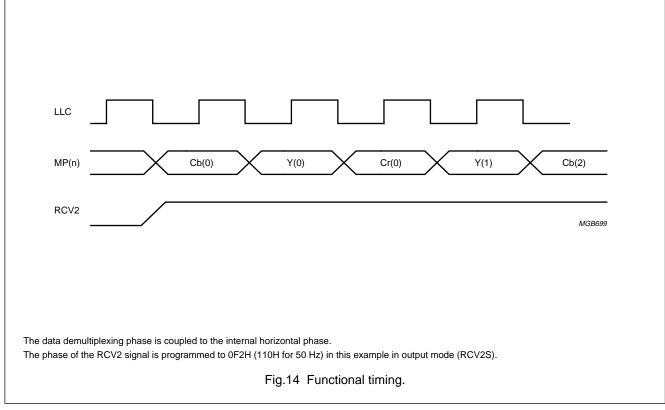
Notes

- 1. At maximum supply voltage with highly active input signals.
- 2. The levels have to be measured with load circuits of 1.2 k Ω to 3.0 V (standard TTL load) and C_L = 25 pF.
- 3. The data is for both input and output direction.
- 4. With LLC in input mode. In output mode, with a crystal connected to XTALO/XTALI duty factor is typically 50%.
- 5. If an internal oscillator is used, crystal deviation of nominal frequency is directly proportional to the deviation of subcarrier frequency and line/field frequency.
- 6. For full digital range, without load, $V_{DDA} = 5.0 \text{ V}$. The typical voltage swing is 2.0 V, the typical minimum output voltage (digital zero at DAC) is 0.2 V.

Digital Video Encoder (ECO-DENC)

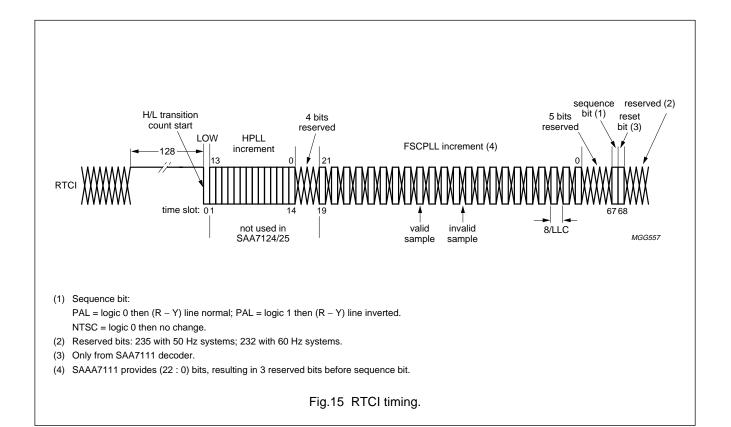
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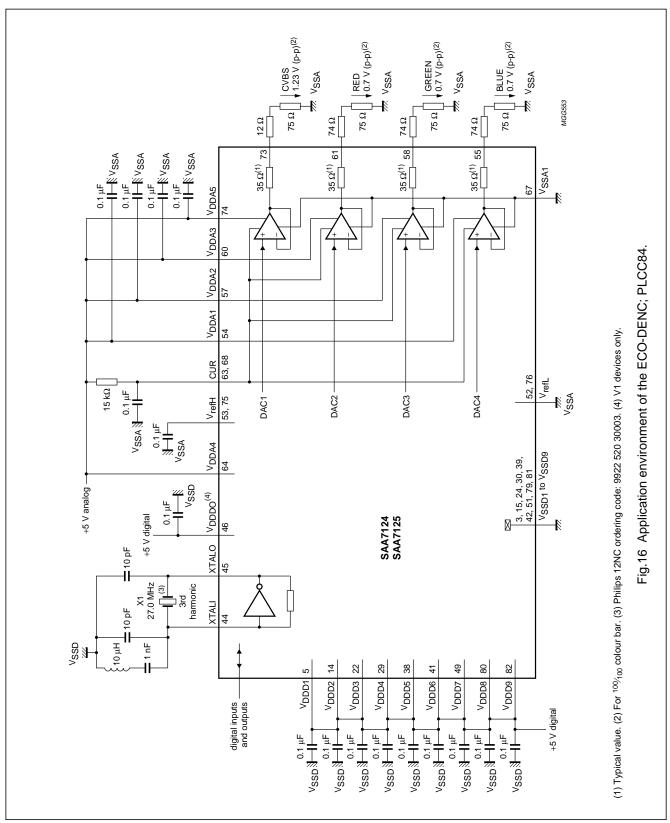
Digital Video Encoder (ECO-DENC)

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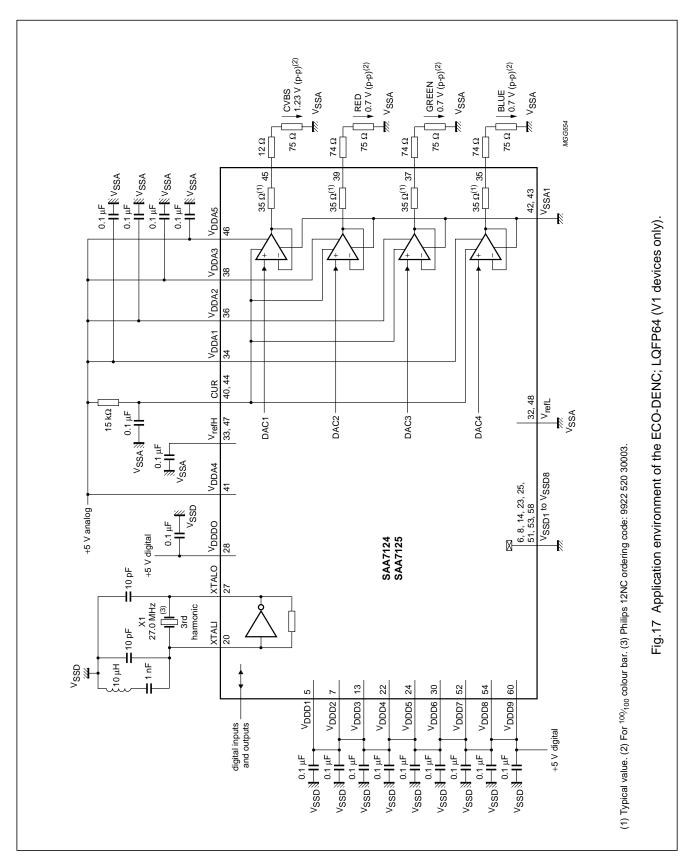


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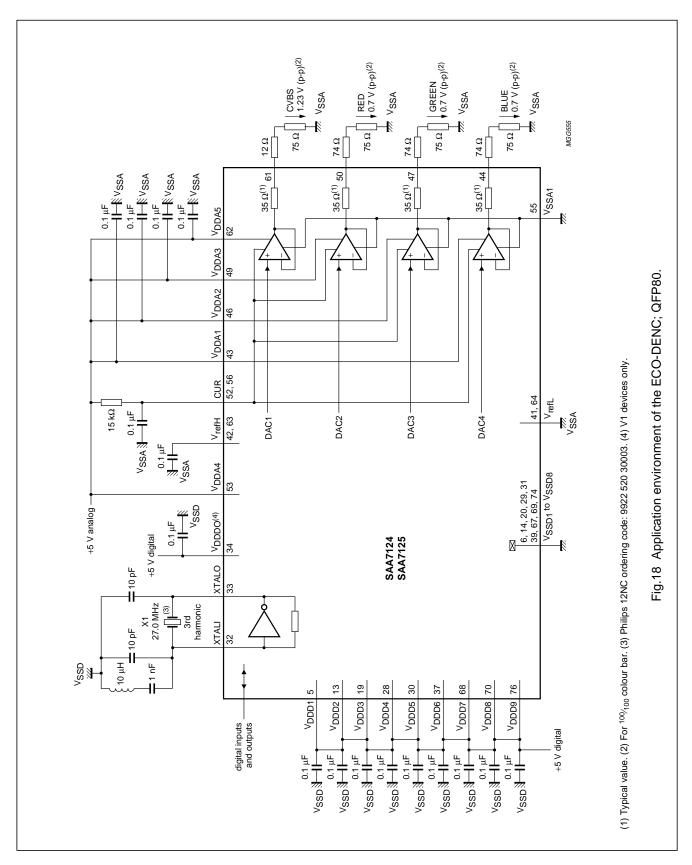
APPLICATION INFORMATION



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SAA7124; SAA7125

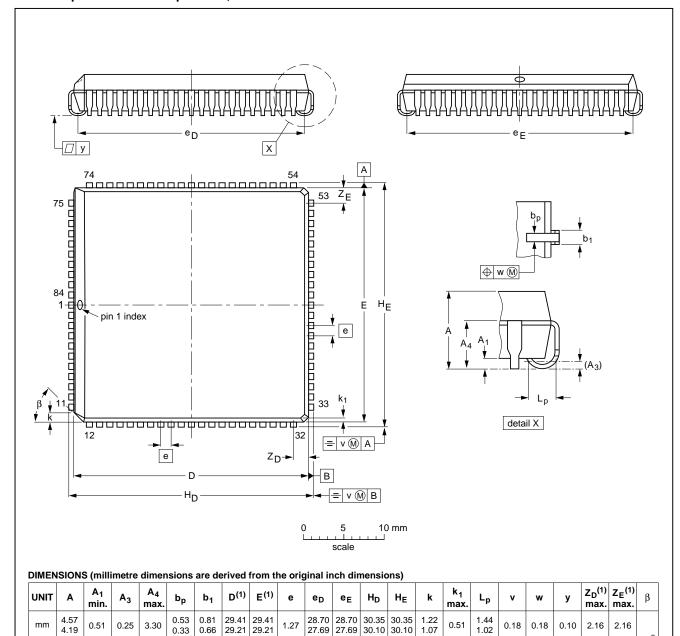


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PACKAGE OUTLINES

PLCC84: plastic leaded chip carrier; 84 leads

SOT189-2



Note

inches

0.180 0.165

0.020 0.01

1. Plastic or metal protrusions of 0.01 inches maximum per side are not included.

0.66

0.032

0.33

0.021

0.013

0.13

29.21

1.158

0.026 | 1.150 |

29.21

1.158

1.150

0.05

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT189-2						92-11-17 95-03-11

27.69

1.130

1.090

27.69

1.130 1.195

30.10 30.10

1.090 | 1.185 | 1.185

1.195

0.048

0.042

0.020

1.02

0.040

0.007 0.007

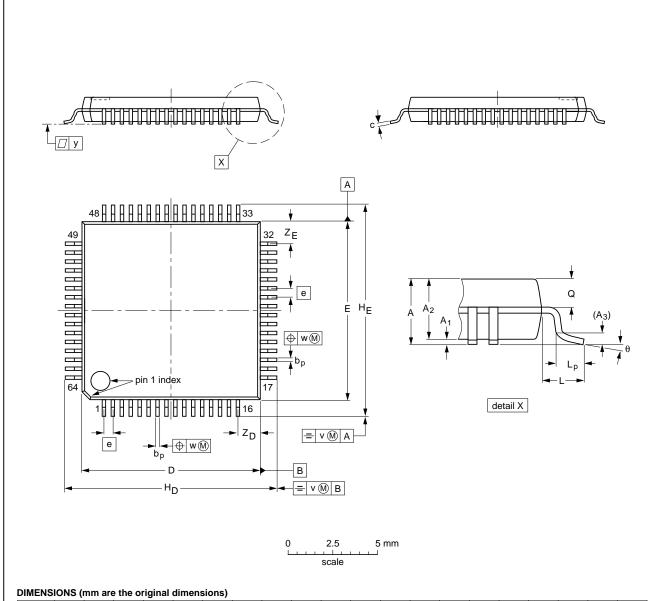
0.004

0.085 0.085

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LQFP64: plastic low profile quad flat package; 64 leads; body 10 x 10 x 1.4 mm

SOT314-2



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	H _D	HE	L	Lp	Q	>	w	у	Z _D ⁽¹⁾	Z _E ⁽¹⁾	θ
mm	1.60	0.20 0.05	1.45 1.35	0.25	0.27 0.17	0.18 0.12	10.1 9.9	10.1 9.9	0.5	12.15 11.85	12.15 11.85	1.0	0.75 0.45	0.69 0.59	0.2	0.12	0.1	1.45 1.05	1.45 1.05	7° 0°

Note

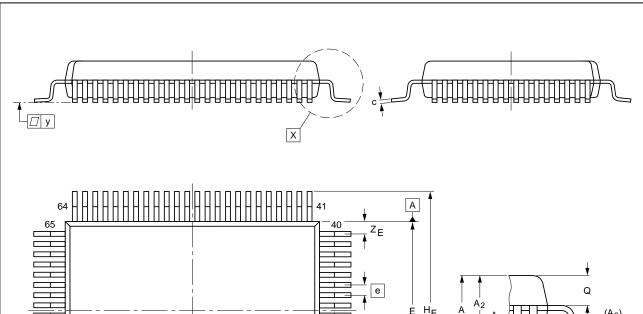
1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

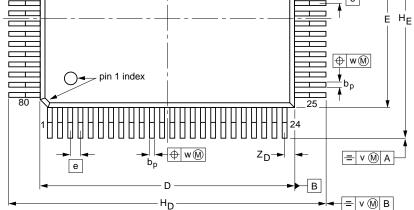
OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT314-2						94-01-07 95-12-19	

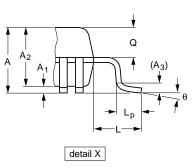
SAA7124; SAA7125

QFP80: plastic quad flat package; 80 leads (lead length 2.35 mm); body 14 x 20 x 2.8 mm

SOT318-3







0 5 10 mm scale

DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	А3	bp	С	D ⁽¹⁾	E ⁽¹⁾	e	H _D	HE	L	Lp	Q	v	w	у	Z _D ⁽¹⁾	Z _E ⁽¹⁾	θ
mm	3.25	0.30 0.10	2.90 2.65	0.25	0.45 0.30	0.25 0.14	20.1 19.9	14.1 13.9	0.8	25.0 24.4	19.0 18.4	2.35	1.4 1.0	1.4 1.2	0.2	0.2	0.1	1.0 0.6	1.2 0.8	7° 0°

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ICCUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT318-3						95-02-04 95-04-25

Digital Video Encoder (ECO-DENC)

SAA7124; SAA7125

SOLDERING

Introduction

There is no soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and surface mounted components are mixed on one printed-circuit board. However, wave soldering is not always suitable for surface mounted ICs, or for printed-circuits with high population densities. In these situations reflow soldering is often used.

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our "IC Package Databook" (order code 9398 652 90011).

Reflow soldering

Reflow soldering techniques are suitable for all PLCC and QFP packages.

The choice of heating method may be influenced by larger PLCC or QFP packages (44 leads, or more). If infrared or vapour phase heating is used and the large packages are not absolutely dry (less than 0.1% moisture content by weight), vaporization of the small amount of moisture in them can cause cracking of the plastic body. For more information, refer to the Drypack chapter in our "Quality Reference Handbook" (order code 9397 750 00192).

Reflow soldering requires solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the printed-circuit board by screen printing, stencilling or pressure-syringe dispensing before package placement.

Several techniques exist for reflowing; for example, thermal conduction by heated belt. Dwell times vary between 50 and 300 seconds depending on heating method. Typical reflow temperatures range from 215 to 250 °C.

Preheating is necessary to dry the paste and evaporate the binding agent. Preheating duration: 45 minutes at 45 °C.

Wave soldering

PLCC

Wave soldering techniques can be used for all PLCC packages if the following conditions are observed:

 A double-wave (a turbulent wave with high upward pressure followed by a smooth laminar wave) soldering technique should be used.

- The longitudinal axis of the package footprint must be parallel to the solder flow.
- The package footprint must incorporate solder thieves at the downstream corners.

QFP

Wave soldering is **not** recommended for QFP packages. This is because of the likelihood of solder bridging due to closely-spaced leads and the possibility of incomplete solder penetration in multi-lead devices.

If wave soldering cannot be avoided, the following conditions must be observed:

- A double-wave (a turbulent wave with high upward pressure followed by a smooth laminar wave) soldering technique should be used.
- The footprint must be at an angle of 45° to the board direction and must incorporate solder thieves downstream and at the side corners.

Even with these conditions, do not consider wave soldering the following packages: QFP52 (SOT379-1), QFP100 (SOT317-1), QFP100 (SOT317-2), QFP100 (SOT382-1) or QFP160 (SOT322-1).

METHOD (PLCC AND QFP)

During placement and before soldering, the package must be fixed with a droplet of adhesive. The adhesive can be applied by screen printing, pin transfer or syringe dispensing. The package can be soldered after the adhesive is cured.

Maximum permissible solder temperature is 260 °C, and maximum duration of package immersion in solder is 10 seconds, if cooled to less than 150 °C within 6 seconds. Typical dwell time is 4 seconds at 250 °C.

A mildly-activated flux will eliminate the need for removal of corrosive residues in most applications.

Repairing soldered joints

Fix the component by first soldering two diagonally-opposite end leads. Use only a low voltage soldering iron (less than 24 V) applied to the flat part of the lead. Contact time must be limited to 10 seconds at up to 300 °C. When using a dedicated tool, all other leads can be soldered in one operation within 2 to 5 seconds between 270 and 320 °C.

Digital Video Encoder (ECO-DENC)

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DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	

Limiting values

Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

LIFE SUPPORT APPLICATIONS

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NOTES

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NOTES

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Printed in The Netherlands

657021/1200/01/pp44

Date of release: 1996 Nov 07

Document order number: 9397 750 01467

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